
3SK300

Silicon N Channel Dual Gate MOS FET
UHF / VHF RF amplifier

HITACHI

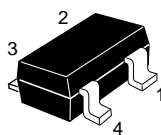
ADE-208-449(Z)
1st. Edition
April 1996

Features

- Low noise figure NF = 1.0dB typ. at f = 200MHz
- High gain PG = 27.6dB typ. at f = 200MHz

Outline

MPAK-4



1. Source
2. Gate1
3. Gate2
4. Drain

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Absolute Maximum Ratings (Ta = 25°C)

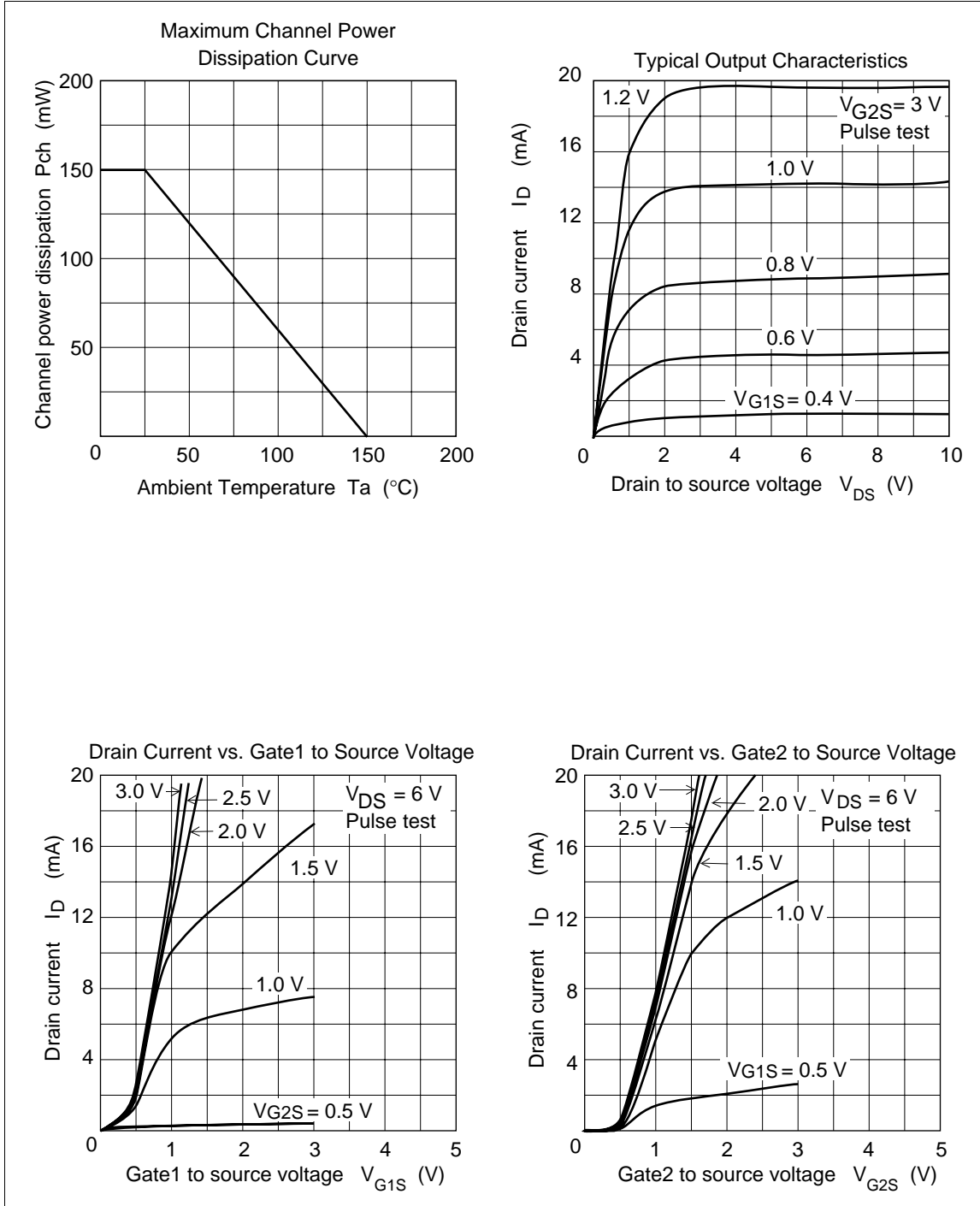
Item	Symbol	Ratings	Unit
Drain to source voltage	VDS	14	V
Gate1 to source voltage	VG1S	±8	V
Gate2 to source voltage	VG2S	±8	V
Drain current	ID	25	mA
Channel power dissipation	Pch	150	mW
Channel temperature	Tch	150	°C
Storage temperature	Tstg	-55 to +150	°C

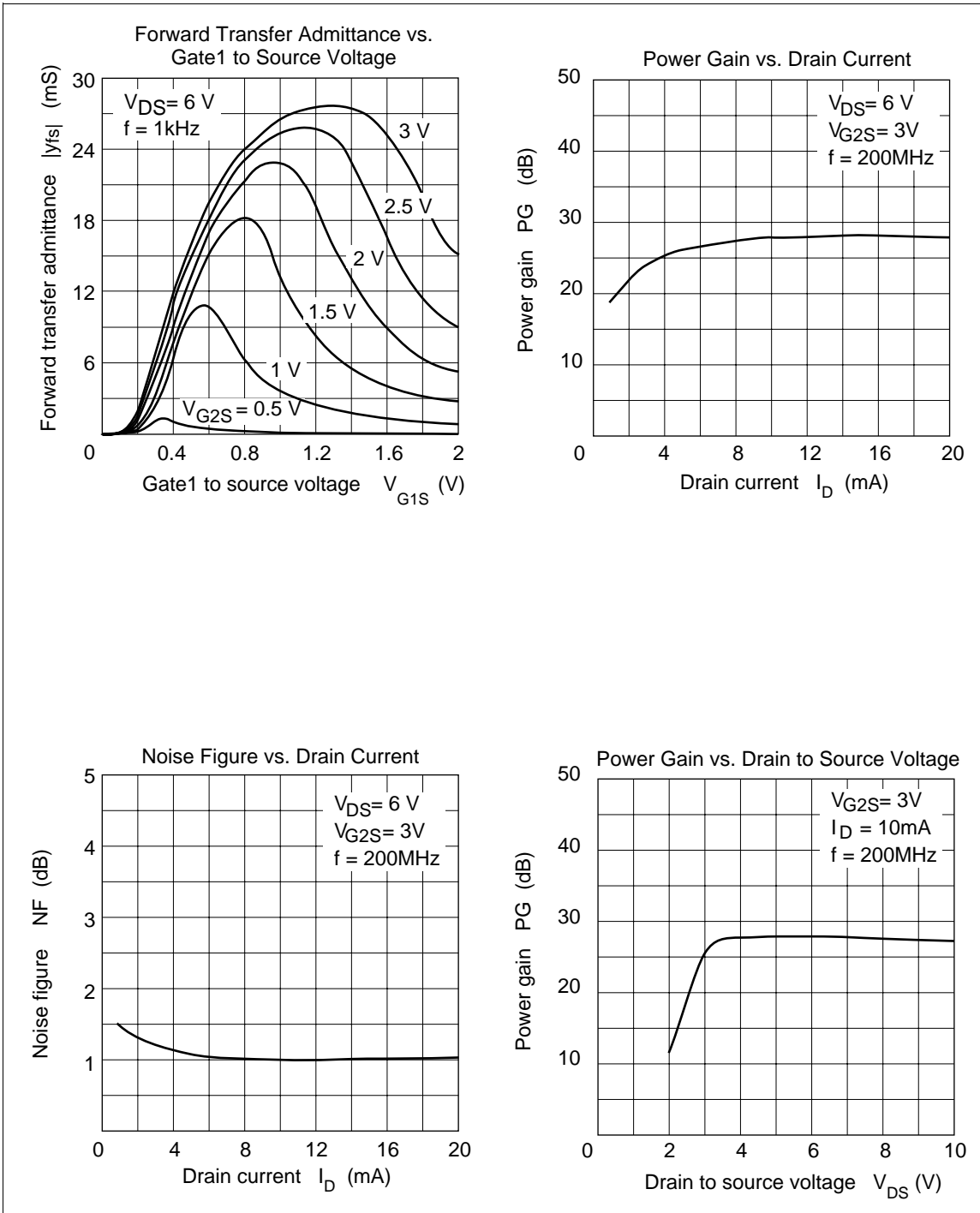
Electrical Characteristics (Ta = 25°C)

Item	Symbol	Min	Typ	Max	Unit	Test Conditions
Drain to source breakdown voltage	V(BR)DSX	14	—	—	V	ID = 200μA, VG1S = -3V, VG2S = -3V
Gate1 to source breakdown voltage	V(BR)G1S S	±8	—	—	V	IG1 = ±10μA, VDS = VG2S = 0
Gate2 to source breakdown voltage	V(BR)G2S S	±8	—	—	V	IG2 = ±10μA, VDS = VG1S = 0
Gate1 cutoff current	IG1SS	—	—	±100	nA	VG1S = ±6V, VDS = VG2S = 0
Gate2 cutoff current	IG2SS	—	—	±100	nA	VG2S = ±6V, VDS = VG1S = 0
Drain current	IDS(op)	4	8	14	mA	VDS = 6V, VG1S = 0.75V, VG2S = 3V
Gate1 to source cutoff voltage	VG1S(off)	0	+0.2	+1.0	V	VDS = 10V, VG2S = 3V, ID = 100μA
Gate2 to source cutoff voltage	VG2S(off)	0	+0.3	+1.0	V	VDS = 10V, VG1S = 3V, ID = 100μA
Forward transfer admittance	yfs	20	25	—	mS	VDS = 6V, VG2S = 3V, ID = 10mA, f = 1kHz
Input capacitance	Ciss	2.4	3.1	3.5	pF	VDS = 6V,
Output capacitance	Coss	0.8	1.1	1.4	pF	VG2S = 3V, ID = 10mA
Reverse transfer capacitance	Crss	—	0.021	0.04	pF	f = 1MHz
Power gain	PG	24	27.6	—	dB	VDS = 6V, VG2S = 3V,
Noise figure	NF	—	1.0	1.5	dB	ID = 10mA, f = 200MHz
Power gain	PG	12	15.6	—	dB	VDS = 6V, VG2S = 3V,
Noise figure	NF	—	3.0	4.0	dB	ID = 10mA, f = 900MHz
Noise figure	NF	—	2.7	3.5	dB	VDS = 6V, VG2S = 3V, ID = 10mA, f = 60MHz
Note:	Marking is "ZR-".					

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Main Characteristics





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